# **SWITCHMODE** <sup>™</sup> **Power Rectifier**

The SWITCHMODE power rectifier, a state-of-the-art device, employs the use of the Schottky Barrier principle with a Platinum barrier metal.

#### **Features**

- Dual Diode Construction; Terminals 1 and 3 May Be Connected for Parallel Operation at Full Rating
- 30 V Blocking Voltage
- Low Forward Voltage Drop
- Guardring for Stress Protection and High dv/dt Capability
- 175°C Operating Junction Temperature
- Pb-Free Package is Available\*

# **Mechanical Characteristics**

- Case: Epoxy, Molded. Epoxy Meets UL 94 V-0 @ 0.125 in
- Weight: 4.3 Grams (Approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- ESD Ratings: Machine Model, B (< 400 V)

Human Body Model, 3B (> 8000 V)

# **MAXIMUM RATINGS**

Rating	Symbol	Max	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	30	V
Average Rectified Forward Current (Rated $V_R$ , $T_C = 100^{\circ}C$ ) Per Leg Per Device	I <sub>F(AV)</sub>	35 70	A
Peak Repetitive Forward Current, (Rated V <sub>R</sub> , Square Wave, 20 kHz, T <sub>C</sub> = 100°C)	I <sub>FRM</sub>	70	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	500	A
Peak Repetitive Reverse Current (2.0 μs, 1.0 kHz)	I <sub>RRM</sub>	2.0	Α
Storage Temperature Range	T <sub>stg</sub>	-55 to +175	°C
Operating Junction Temperature (Note 1)	TJ	-55 to +175	°C
Voltage Rate of Change (Rated V <sub>R</sub> )	dv/dt	10,000	V/μs

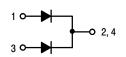
Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

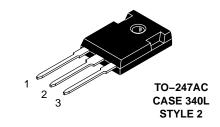


# ON Semiconductor®

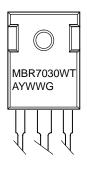
http://onsemi.com

# SCHOTTKY BARRIER RECTIFIER 70 AMPERES, 30 VOLTS





# **MARKING DIAGRAM**



A = Assembly Location

Y = Year WW = Work Week G = Pb-Free Package

# **ORDERING INFORMATION**

Device	Package	Shipping
MBR7030WT	TO-247	30 Units/Rail
MBR7030WTG	TO-247 (Pb-Free)	30 Units/Rail

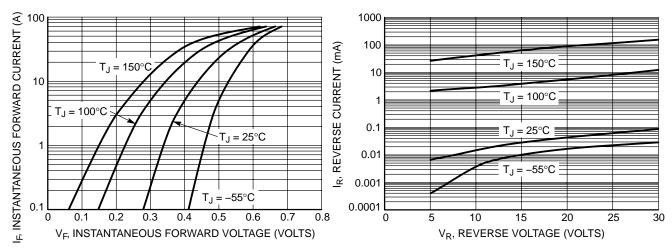
<sup>1.</sup> The heat generated must be less than the thermal conductivity from Junction–to–Ambient:  $dP_D/dT_J < 1/R_{\theta JA}$ .

<sup>\*</sup>For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

# THERMAL CHARACTERISTICS (Per Diode)

Rating	Symbol	Max	Unit
Thermal Resistance, Junction-to-Case	$R_{ heta JC}$	0.55	°C/W
ELECTRICAL CHARACTERISTICS (Per Diode)			
Instantaneous Forward Voltage (Note 2) @ I <sub>F</sub> = 35 Amps, T <sub>C</sub> = 25°C	V <sub>F</sub>	0.55	V

# **TYPICAL CHARACTERISTICS**



**Figure 1. Typical Forward Voltage** 

**Figure 2. Typical Reverse Current** 

<sup>2.</sup> Pulse Test: Pulse Width = 300 μs, Duty Cycle < 2.0%

# **TYPICAL CHARACTERISTICS**

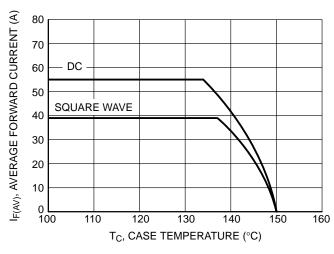


Figure 3. Current Derating (Case)

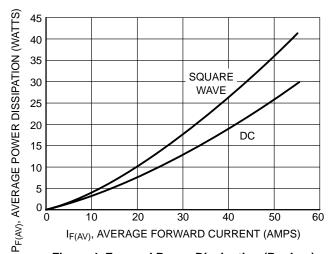


Figure 4. Forward Power Dissipation (Per Leg)

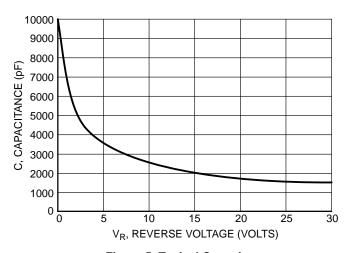
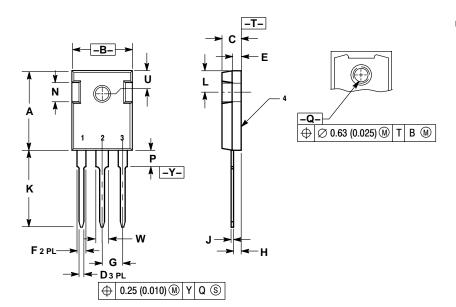


Figure 5. Typical Capacitance

# PACKAGE DIMENSIONS

**TO-247 PSI PLASTIC** CASE 340L-02 ISSUE D



- DIMENSIONING AND TOLERANCING PER ANSI
- 2. CONTROLLING DIMENSION: MILLIMETER.

	MILLIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
Α	20.32	21.08	0.800	8.30
В	15.75	16.26	0.620	0.640
C	4.70	5.30	0.185	0.209
D	1.00	1.40	0.040	0.055
Е	2.20	2.60	0.087	0.102
F	1.65	2.13	0.065	0.084
G	5.45 BSC		0.215 BSC	
Н	1.50	2.49	0.059	0.098
۲	0.40	0.80	0.016	0.031
K	20.06	20.83	0.790	0.820
L	5.40	6.20	0.212	0.244
N	4.32	5.49	0.170	0.216
Р		4.50		0.177
Ø	3.55	3.65	0.140	0.144
U	6.15	6.15 BSC 0.242 BSC		BSC
W	2.87	3.12	0.113	0.123

- STYLE 2: PIN 1. ANODE 2. CATHODE (S) 3. ANODE 2
  - 4. CATHODES (S)

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